

Erik MacLennan

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Technical Skills Summary

Software	Mechanical	Electrical
• C++, Python (Django), MATLAB, JavaScript (Node.js), Swift • Version control (git) • AWS (S3, RDS, EC2) • LabVIEW 2017 (G), NI VeriStand	• Prototyping (3D Printing, laser cutting, water-jet cutting, basic metalwork) • SOLIDWORKS 2025 (CSWP, CSWPA-SM, CSWPA-WD), CATIA V5 • GD&T (per ASME Y14.5M-1994)	• Oscilloscope, multimeter • PCBA schematic, layout design (Altium) • Circuit analysis (SPICE) • CAN, I²C, SPI, SDI-12

Education

2014 - 2019 **BASc Engineering Physics, University of British Columbia (UBC)**

- 16 months co-op work experience (UBC Science Co-op)
- UBC Formula Electric, Accumulator Lead (Formula SAE Electric student team)
- Faculty Award, 2019 Faculty of Applied Science Design and Innovation Day

Work Experience

Iota Biosciences, Alameda

February 2026 - Present **Staff Systems Engineer**

- Exoskeleton Technical Lead

May 2025 - **Senior Systems Engineer**

- Technical Lead for design, prototyping, and verification of wearable robotic exoskeleton systems from concept through clinical evaluation.
- Derive device and product requirements from user needs and regulatory standards.
- Collaborate with clinicians, therapists, and users to evaluate device safety and effectiveness

March 2023 - **Senior Test Engineer, ATE**

May 2025 Develop equipment to test electronics for novel, active implantable medical devices.

- Create automated test systems (ATE) for use in R&D, manufacturing, and design verification activities.
- Work closely within R&D to support testing that helps drive design decisions.
- Deploy and maintain test equipment at multiple production facilities.

Systems Engineer, Precision NanoSystems, Vancouver

January 2020 - March 2023 (3yrs, 2mos) Supported current engineering activities across multiple high-precision microfluidic research-use instruments.

- Developed testing criteria and electromechanical test jigs to maintain a high level of consistency in outgoing instruments.
- Primary point of contact for technical field escalations and subsequent root cause investigation, corrective action implementation.
- Primary technical owner of all custom circuit board assemblies. Debug non-conformances and lead the design of PCBA updates.
- Build and manage internal software tooling to better facilitate internal processes, including product lifecycle management/version control, corrective action/root cause analysis, and internal documentation.

March 2019 - January 2020 (9 months) **Full-Stack Software Engineer, UBC Ecohydrology, Vancouver**

Development of an end-to-end solution for capturing sensor data from remote deployment locations in North and South America to support research in water/land use practices.

- Full design and bring-up of a custom circuit board assembly complete with LoRa radio, GPS, and power management functionality.
- Firmware for the embedded system written for data acquisition from 20+ sensor variants with various communication protocols, and wireless transmission with LoRa. Written in C++ in an OOP model.
- Created and maintained a relational database for sensor data, along with a web front-end for data accessibility and visualization purposes. Written in the Django framework for Python, hosted with various AWS services.

May -
August 2018
(4 months)

Drive Systems Test Engineering Intern, Tesla, Inc., Palo Alto

Development of test equipment for the Tesla Model 3 Drive Unit (3DU).

- Created LabVIEW APIs for interfacing with Tesla drive inverters, in-house power distribution units, and other CAN devices.
- Designed and fabricated a new 3DU motor mount for use in production, with potential application in Service centres. Mass optimization and DFM emphasized. 10+ units manufactured and in use.
- Collaborated with Production Engineers across multiple production lines to quantify inefficiencies and design solutions to mitigate them.

May -
December
2017
(8 months)

Systems/Electro-mechanical Engineering Co-op, Kodak, Vancouver

Developed precision opto-mechanical test jigs that interface with peripherals including power meters, linear actuators, USB cameras, and Kodak's thermal imaging heads.

- Performed a LabVIEW application for image acquisition and live analysis for automatic micron precision alignment and quality control of optical components during production.